Soldering Specifications

Table (1.1): Reflow Profiles

Profile Type:	Pb-Free Assembly	
Preheat		
-Temperature Min(T _{smin})	150 °C	
-Temperature Max(T _{smax})	200 °℃	
-Time(t_s)from(T_{smin} to T_{smax})	60-120seconds	
Ramp-up rate(T _L to T _p)	3°ℂ/second max.	
Liquidus temperature(T _L)	217°℃	
$Time(t_L)maintained$ above T_L	60-150 seconds	
Classification temperature(T _c)	See Table (1.2)	
Time(tp) at Tc- 5℃ (Tp should be equal to or less than Tc.)	*< 30 seconds	
Ramp-down rate(T_p to T_L)	6°C /second max.	
Time 25℃ to peak temperature	8 minutes max.	

Tp: maximum peak package body temperature, **Tc**: the classification temperature.

For user (customer) **Tp** should be equal to or less than **Tc**.

Table (1.2) Package Thickness/Volume and Classification Temperature(Tc)

	Package	Volume mm ³	Volume mm ³	Volume mm ³
	Thickness	<350	350-2000	>2000
PB-Free Assembly	<1.6mm	260℃	260℃	260 ℃
	1.6-2.5mm	260℃	250 ℃	245℃
	≥2.5mm	250℃	245℃	245℃

Reflow is referred to standard IPC/JEDEC J-STD-020E

^{*} Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.

Notes

- (1) When there are questions concerning measurement result : measurement shall be made after 48 ± 2 hours of recovery under the standard condition
- (2) This power choke coil itself does not have any protective function in abnormal condition such as overload, short-circuit and open-circuit conditions, etc. Therefore, it shall be confirmed as the end product that there is no risk of smoking, fire, dielectric withstand voltage, insulation resistance, etc. in abnormal conditions to provide protective devices and/or protection circuit in the end product.
- (3) When this power choke coil was used in a similar or new product to the original one, sometimes it might not be able to satisfy the specifications due to different condition of use.
- (4) Dielectric withstanding test with higher voltage than specific value will damage insulating material and shorten its life.
- (5) This power choke coil must not be used in wet condition by water, coffee or any liquid because insulation strength becomes very low in this condition.
- (6) Please consult our company to confirm the reliability of the process required to wash or use or exposure to a chemical solvent used in this product. PCB washing tested to MIL-STD-202 Method, and dry it off immediately.
- (7) The rated current as listed is either the saturation current or the heating current depending on which value is lower.
- (8) If this power choke is dipped in the cleaning agent, such as toluene, xylene, ketone, and ether system, there is a possibility that the performance decreases greatly , and marking disappearanc .
- (9) The high power ultrasonic washing may damage the choke body •